

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

: MAIL STOP: RCE

Akihisa HONGO et al.

Docket No. 2001 0133A

Serial No. 09/762,582

Group Art Unit 1753

Filed April 12, 2001

Examiner Brian Mutschler

SUBSTRATE PLATING METHOD AND APPARATUS Confirmation No. 5731

## PRELIMINARY AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 THE COMMISSIONER IS AUTH TO CHARGE ANY DEFICIENCY OF FEES FOR THIS PAPER TO DEPO ACCOUNT NO. 23-0975

Sir:

In response to the Office Action of October 27, 2004, the period for response to which having been extended by three months to April 27, 2005, please amend the above-identified U.S. Patent application as follows: